ABSOCIATION CONNECTING LECTRONICS INDUSTRIES® INFORMATION CONNECTING	. Bannockb	urn. Illinois. A	ll rights reserved u tions.	nder both	This docum level parts,	ent is a declaration er	n of the subst compasses all	ances within the manuf lower level materials f	acturer liste or which the	d item. Note: it e manufacturer	f the item is an as has engineering	ssembly with lower responsibility.	
	IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175xFor Dis				pe * Declaration Class * class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Infe					Mfg Informati	on		
Supplier Information													
Company name* Company			pany unique ID			Unique ID Authority				Response Date*			
onsemi										2024-05-17			
Contact Name Title - Contact			itact			Phone - Contact*			Emai	Email - Contact*			
Product-Env-Stewards Product Envi			nviro Compliance			NA			Prod	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Repres			sentative			Phone - Representative*			Emai	Email - Representative*			
Product-Env-Stewards Product Env			nviro Compliance			NA			Prod	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item Number		Mfr Item Name			Effective Date	Version	Manufacturing Sit	e	Weight*	UOM	Unit Type	
	ADT7483	DT7483AARQZ-RL 2 TMP DIO MO		/SMBUS INT	ABUS INT 202			PH1	PH1		mg	Each	
Manufacturing Proccess Information	on												
Terminal Plating / Grid Array Mate	Terminal Plating / Grid Array Material Terminal Base A		Alloy J	J-STD-020 MSL Rating			Peak Process Body Temperature Max Time at Peak T			Temperature Number of Reflow Cycles			
Matte Tin (Sn) - annealed CU Alloy		1	l		260	С	30	sec	conds 3				
Comments													
level 1 - maximum time at peak temperature	e during sol	dering is 10-3	0 seconds										
For more information regarding material co	mposition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	HS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead b), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl thalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.3	mg	Supplier	Silicon (Si)	7440-21-3		1.3	mg
Die Attach	0.31	mg	Supplier	Silver (Ag)	7440-22-4		0.2325	mg
			Supplier	Epoxy resins	129915-35-1		0.0775	mg
Lead Frame	31.11	mg	Supplier	Silver (Ag)	7440-22-4		0.4449	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0373	mg
			Supplier	Iron (Fe)	7439-89-6		0.7218	mg
			Supplier	Copper (Cu)	7440-50-8		29.8967	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0093	mg
Mold Compound-Black	43.0	mg		Epoxy Phenol Resin	proprietary data		4.515	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		38.485	mg
Plating	0.86	mg	Supplier	Tin (Sn)	7440-31-5		0.86	mg
Wire Bond - Au	0.42	mg	Supplier	Gold (Au)	7440-57-5		0.42	mg